

SEMICONDUCTOR®

## FCPF190N60E\_F152 N-Channel SuperFET<sup>®</sup> II MOSFET 600 V, 20.6 A, 190 mΩ

## Features

- 650 V @T<sub>J</sub> = 150°C
- Max. R<sub>DS(on)</sub> = 190 mΩ
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 63 nC)
- Low Effective Output Capacitance (Typ. C<sub>oss</sub>.eff = 178 pF)
- 100% Avalanche Tested

## Aplications

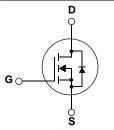
LCD / LED / PDP TV Lighting

GDS

- Solar Inverter
- AC-DC Power Supply



SuperFET<sup>®</sup>II MOSFET is Fairchild Semiconductor<sup>®</sup>'s first generation of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET<sup>®</sup>II MOSFET is suitable for various AC/DC power conversion for system miniaturization and higher efficiency.



## MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

TO-220F

Symbol		Parameter		FCPF190N60E_F152	Unit	
V <sub>DSS</sub>	Drain to Source Voltage			600	V	
V <sub>GSS</sub>		- DC		±20	V	
	Gate to Source Voltage	- AC	(f > 1 Hz)	±30	V	
I <sub>D</sub> C	Desir Courset	-Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)	continuous (T <sub>C</sub> = 25°C)		٨	
	Drain Current	-Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		13.1*	— A	
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	61.8*	Α	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		(Note 2)	400	mJ	
I <sub>AR</sub>	Avalanche Current		(Note 1)	4.0	Α	
E <sub>AR</sub>	Repetitive Avalanche Energy		(Note 1)	2.1	mJ	
Pea	Peak Diode Recovery dv/dt		(Note 3)	20	V/ns	
dv/dt	MOSFET dv/dt			100	V/115	
P <sub>D</sub>	Bower Dissipation	(T <sub>C</sub> = 25°C)		39	W	
	Power Dissipation	- Derate above 25°C		0.31	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Tempe	rature Range		-55 to +150	°C	
Τ <sub>L</sub>	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

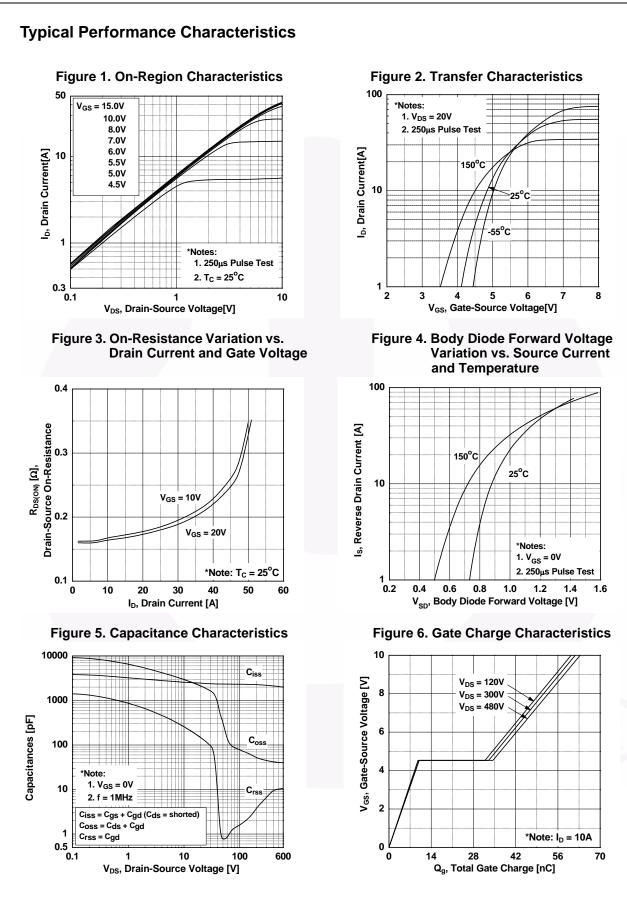
\*Drain current limited by maximum junction temperature

## **Thermal Characteristics**

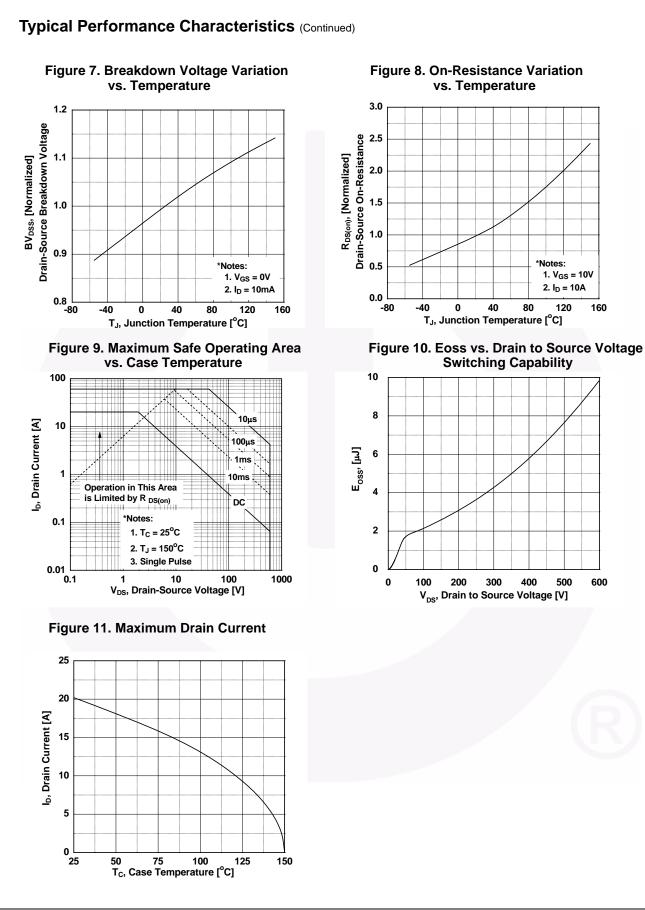
Symbol	Parameter	FCPF190N60E_F152	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	3.2	
$R_{\theta CS}$	Thermal Resistance, Case to Heat Sink (Typical)	0.5	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	62.5	

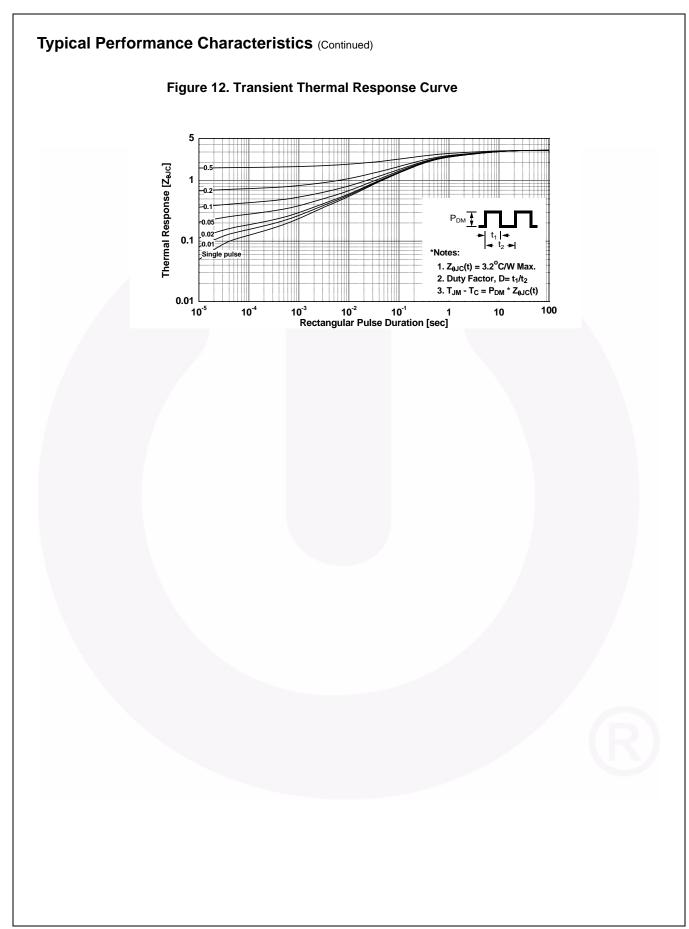
Device N	larking	Device	Package	Eco Status	Pack	caging T	уре	Quanti	ity
FCPF190N60E FCPF190N60E_F152		FCPF190N60E_F152	TO-220F	Green 🧭		Tube		50	
		"green" Eco Status, please visit: racteristics $T_{C} = 25^{\circ}C$			//green/r	ohs_gree	en.html.		
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Unit
Off Chara	cteristic	;5						1	
3V <sub>DSS</sub>	Drain t	o Source Breakdown Voltage		$F_{SS} = 0V, I_D = 10mA, T_J = 25$		600	-	-	V
ABV <sub>DSS</sub>	Brooke	lown Voltage Temperature		$_{\rm SS} = 0$ V, $I_{\rm D} = 10$ mA, $T_{\rm J} = 15$		650	-	-	V
$\Delta T_J$	Coeffic		I <sub>D</sub>	= 10mA, Referenced to 25	°C	-	0.67	-	V/ºC
BV <sub>DS</sub>		Source Avalanche Breakdow	n v.	<sub>SS</sub> = 0V, I <sub>D</sub> = 20A			700	_	V
	Voltage	9				_	700		v
DSS	Zero G	Gate Voltage Drain Current		$v_{S} = 480V, V_{GS} = 0V$		-	-	10	μA
	0-1-1	De la la slava Ormani		$p_{\rm S} = 480 \text{V}, \text{T}_{\rm C} = 125^{\circ} \text{C}$		-	-	10	
GSS	Gate to	Body Leakage Current	Vc	$_{\text{SS}} = \pm 20 \text{V}, \text{V}_{\text{DS}} = 0 \text{V}$		-	-	±100	μA
On Chara	cteristic	s							
/ <sub>GS(th)</sub>	Gate T	hreshold Voltage	V	<sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250μA		2.5	-	3.5	V
RDS(on)		Drain to Source On Resistand		$_{3S} = 10V, I_{D} = 10A$		-	0.16	0.19	Ω
JFS		rd Transconductance		$p_{\rm S} = 20V, I_{\rm D} = 10A$		-	20	-	S
	01	- vieties					I		
)ynamic						_			
C <sub>iss</sub>	-	apacitance	V	$V_{DS} = 25V, V_{GS} = 0V$ f = 1MHz $V_{DS} = 380V, V_{GS} = 0V, f = 1.Hz$			2385	3175	pF
Coss		Capacitance	-			-	1795	2396	pF
C <sub>rss</sub>		e Transfer Capacitance				-	110	165	pF
C <sub>oss</sub>		Capacitance			Hz	-	42	-	pF
C <sub>oss</sub> eff.		ve Output Capacitance	V	$D_{\rm S} = 0$ V to 480V, $V_{\rm GS} = 0$ V		-	178	-	pF
Q <sub>g(tot)</sub>		ate Charge at 10V	V.	$V_{DS} = 380V, I_D = 10A$ $V_{GS} = 10V$ (Note 4)		-	63	82	nC
ຊ <sub>gs</sub>	Gate to	Source Gate Charge	-			-	10	-	nC
ຊ <sub>gd</sub>	Gate to	Drain "Miller" Charge				-	24	-	nC
ESR	Equiva	lent Series Resistance	ies Resistance f =1MHz			-	5	-	Ω
witching	u Charad	cteristics							
		n Delay Time				<u></u>	23	56	ns
d(on) r		n Rise Time	Vr	V <sub>DD</sub> = 380V, I <sub>D</sub> = 10A		_	14	38	ns
r d(off)		ff Delay Time		$_{\rm SS} = 10V, R_{\rm G} = 4.7\Omega$		_	101	212	ns
а(оп) f		ff Fall Time			(Note 4)	-	15	40	ns
•					(11010-1)				
		de Characteristics	5: 1 5	10					
S		um Continuous Drain to Sour				-	·	20.2	A
SM		um Pulsed Drain to Source D				-	-	60.6	A
/ <sub>SD</sub>		Source Diode Forward Volta	-	$_{\text{SS}} = 0\text{V}, \text{I}_{\text{SD}} = 10\text{A}$		-	-	1.2	
rr C		e Recovery Time e Recovery Charge		<sub>GS</sub> = 0V, I <sub>SD</sub> = 10A ⊧/dt = 100A/µs	-	-	308 4.8	-	ns
۵ <sub>rr</sub>	Revers	e Recovery Charge	u	μα = 100Α/μ3		-	4.0	-	μC

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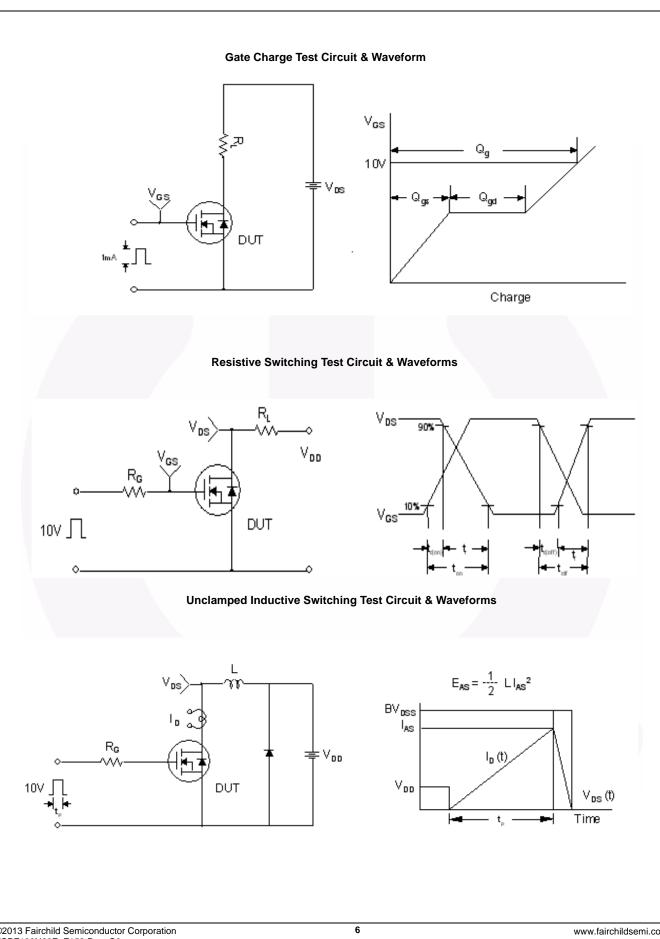


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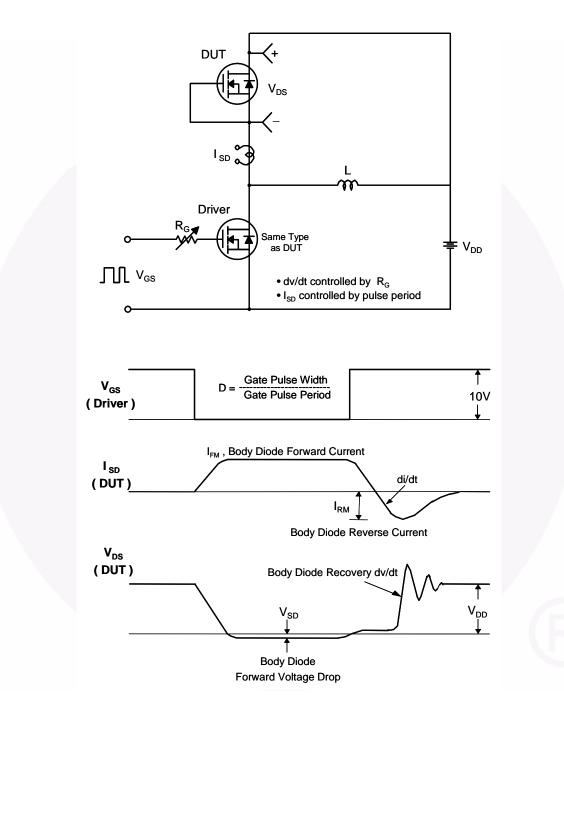


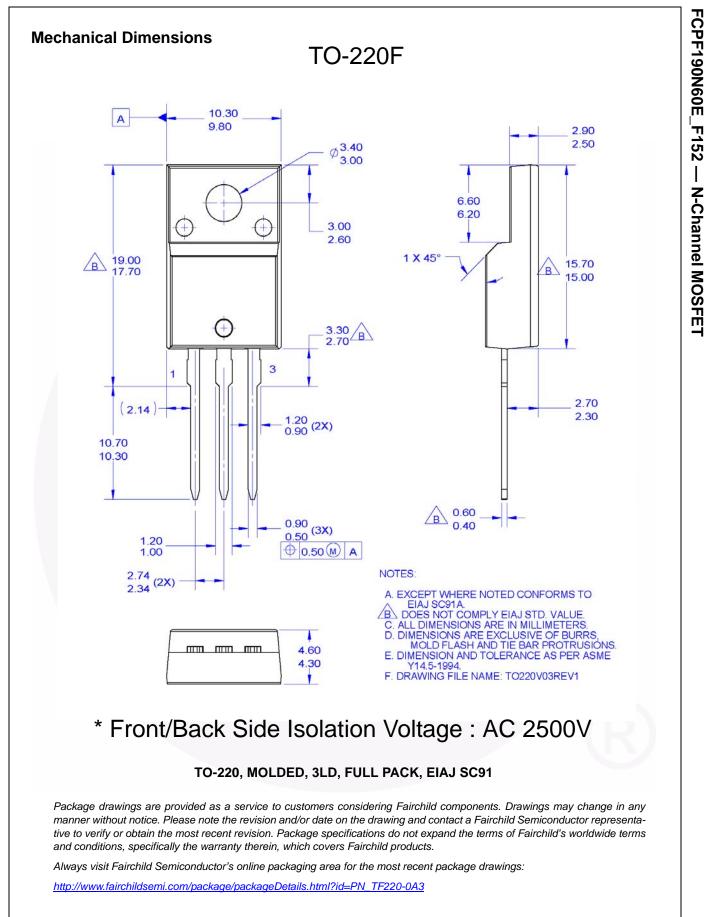
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